

MOSFET BASED DC SOLID-STATE RELAY



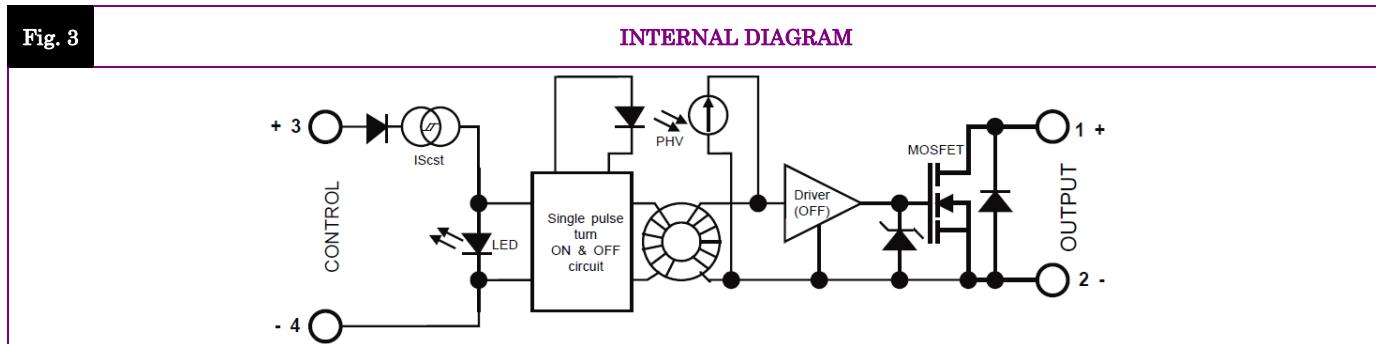
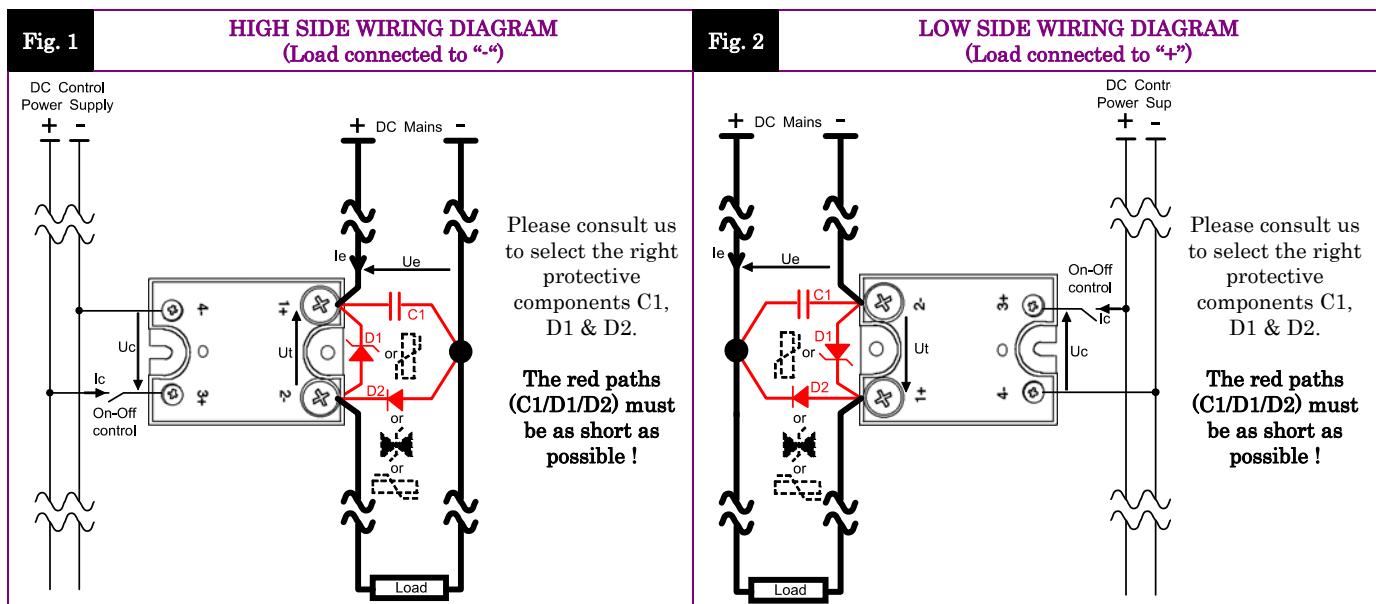
- ▶ Latest MOSFET technology generation.
- ▶ Ultra low on-state resistance.
- ▶ New innovative isolated driver ensuring fast power transistor turn on and off therefore low power transient.
- ▶ Ultra low output leakage current
- ▶ Low control current consumption
- ▶ Triggered control input to avoid linear control risks
- ▶ Low conducted and radiated disturbances

SCM0150100



Control voltage range	4.5-32VDC
Max transient peak voltage	100v
Advised max. DC Mains peak voltage	Depend on the voltage protection
Max. Load Current (with heatsink)	150ADC

DC Mains voltage range	Load current range	Control input voltage range	In & case / Out Insulation	Connections	Dimensions (WxHxD)	Weight
(Depends on protection clamping voltage)	0 to 150A (with heatsink)	4.5-32VDC	4kV	M3 round tabs M5 round tabs	44.5 x 58.2 x 27 (mm)	100g

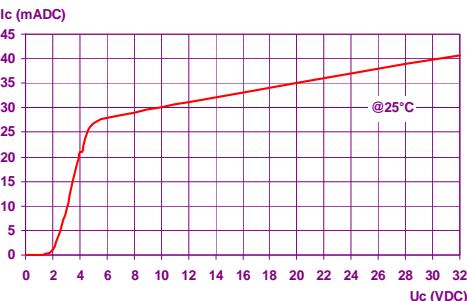


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CONTROL INPUT CHARACTERISTICS

INPUT CIRCUIT	CHARACTERISTIC	LABEL	VALUE	INFO.	Fig. 4	CONTROL CURRENT vs. CONTROL VOLTAGE
	Nom. Control voltage	Ucnom	12-24VDC			
	Nom. Control current	Icnom	35mAADC			
	Control voltage range	Uc	4.5 – 32VDC	typical=4.3V		
	Control current consumption	Ic	25 – 42mAADC	See curve		
	Releasing control voltage	Ucoffmax	1VDC	Typical= 3.5V		
	Max. reverse control voltage	-Ucmax	32VDC	-Icmax <100µA		
	Input impedance	Rin	Current limitation	See curve		



TIME CHARACTERISTICS

TIME CHARACT.	CHARACTERISTIC	LABEL	VALUE	
	Turn on time	ton	10µs	
	Turn on delay	tdon	600µs	
	Turn off time	toff	10µs	
	Turn off delay	tdoff	100µs	
	Max. On-Off frequency	F(on-off)	700Hz	

POWER OUTPUT CHARACTERISTICS

POWER CIRCUIT	CHARACTERISTIC	LABEL	VALUE	INFO.
	Mains voltage range	Ut Ue	Min = RDSon x Ie	Depends on protection clamping voltage (D1)
Non-repetitive peak voltage	Utp		100V	
Overvoltage protection	D1		Not integrated A voltage clamping mean must be connected across the terminals 1 & 2 (see fig 1 & 2)	Please consult us to select the right protective components
Off-state max reverse voltage drop (internal diode)	-Ut		0.85V	@Ie=150A @Uc=0
Maximum nominal currents	Ie max	Resistive		See fig. 9
		150A	Please contact us	
Max. non-repetitive peak current	Iepeak		1000A	See fig. 8
Min. load current	Iemin		0mA	
Max. leakage current	Ielk max		500µA	@Utp @Tjmax
Max. on-state resistance	RDson	1mOhms @Tj=25°C	1.9mOhms @Tj=125°C	@Iemax
Typ. output capacitance	Cout		2.7nF	@Utp
Junction/case thermal resistance	Rthjc		0.45K/W	
Built-in heatsink thermal resistance vertically mounted	Rthra		10K/W	@ΔTra=75°C
Heatsink thermal time constant	Tthra		10 minutes	@ΔTra=60°C
Control inputs/power outputs insulation voltage	Uimp		4kV	
Inputs/case insulation voltage	Uimp		4kV	
Outputs/case insulation voltage	Uimp		4kV	
Isolation resistance	Rio		1GΩ	
Isolation capacitance	Cio		<8pF	
Maximum junction temperature	Tjmax		175°C	
Storage ambient temperature	Tstg		-40->+100°C	
Operating ambient temperature	Tamb		-40->+90°C	See fig. 9
Max. case temperature	Tc		100°C	

OUTPUT SWITCH CHARACTERISTIC CURVES

Fig. 5

ON RESISTANCE VS JUNCTION TEMPERATURE

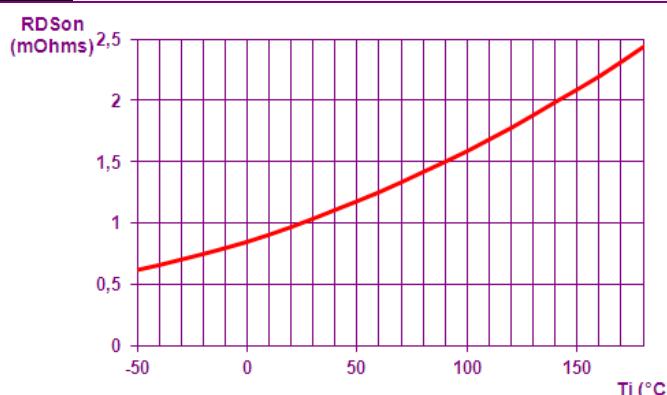


Fig. 6

REVERSE VOLTAGE DROP VS REVERSE CURRENT

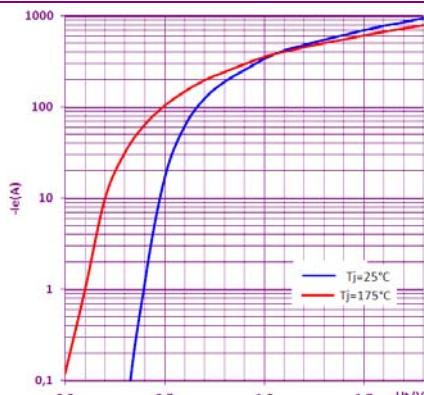


Fig. 7

POWER ELEMENT TRANSIENT THERMAL IMPEDANCE vs. PULSE DURATION

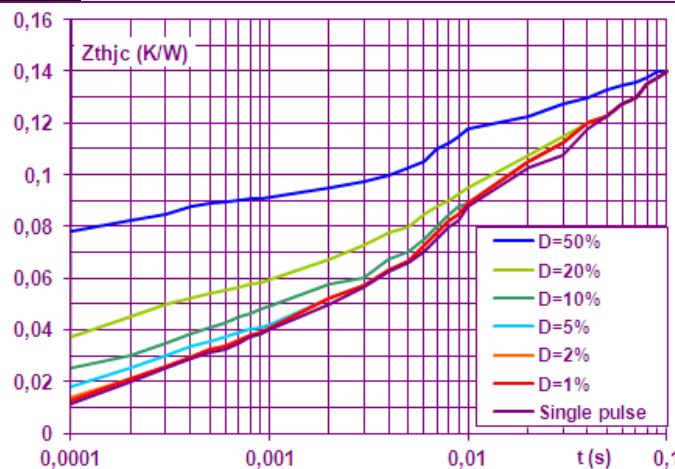


Fig. 8

ON-STATE PEAK OVERLOAD CURRENT vs. PULSE DURATION

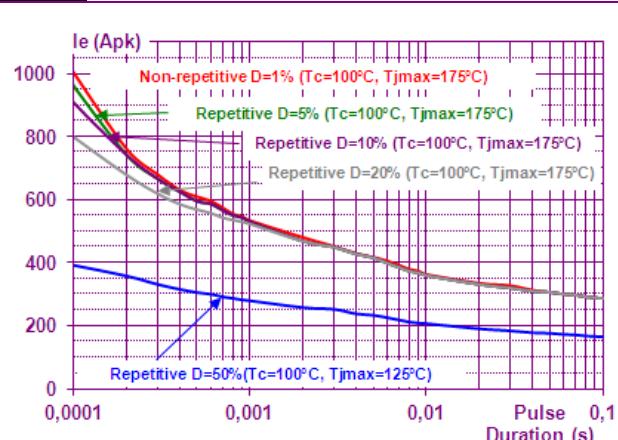


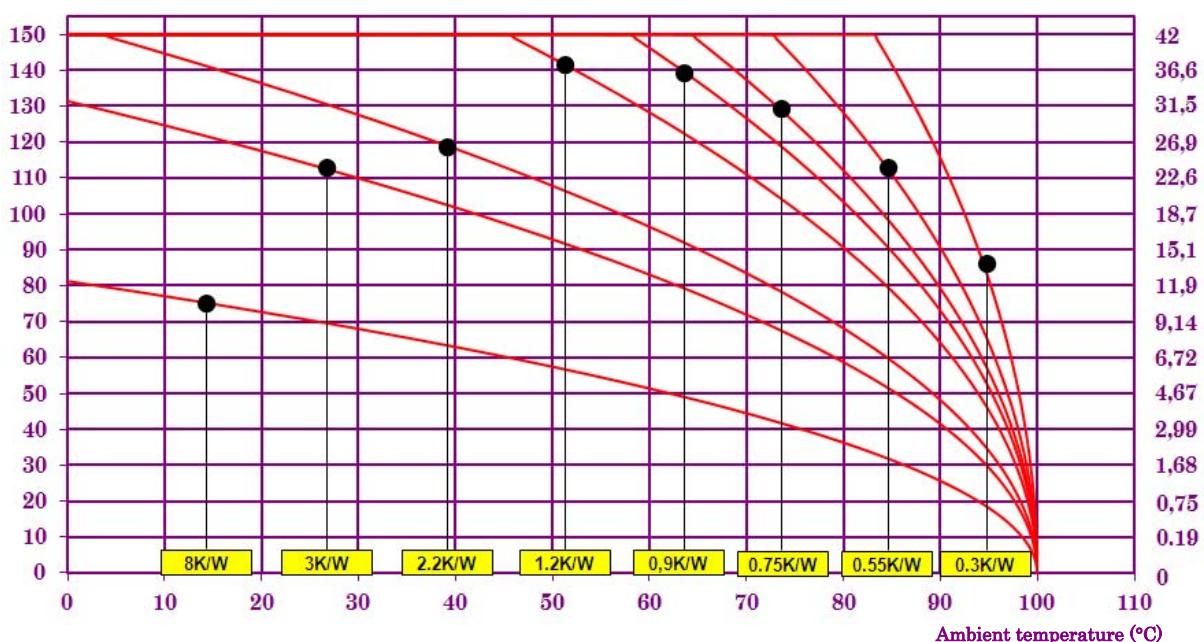
Fig. 9

POWER DISSIPATED AND LOAD CURRENT LIMIT VS TEMPERATURE

Permanent current
Ie (ARMS)

Please refer to the installation notice for precautions about
mounting the device on a heatsink.

Power dissipated
Pd (W)



10K/W = No Heatsink / 1LD12020
2.1K/W = WF210000
0.9K/W = WF115100

4K/W = 150x150x3mm aluminium sheet
1.2K/W = WF121000
0.75K/W = WF070000

2.2K/W = WF262100 / WF151200
1.1K/W = WF131100
0.55K/W = WF050000
0.3K/W = WF031100

GENERAL INFORMATION

CONNEX- TIONS	Connections		Power	Control	
	Screwdriver advised		Philips™ NR2	Philips™ NR1	
	Min and max tightening torque		1.8 N.m	0.8 N.m	
	Insulated crimp terminals (round tabs, eyelet type)		M5	M3	

MISC.	Display		Green LED (indicates relay has switched ON)	
	Housing		UL94V0	
	Mounting		2 screws (M4x12mm)	See mounting sheet
	Noise level		No audible noise	
	Weight		100g	

STANDARDS

GENERAL	Standards		IEC60947-1	
	Protection level		IP00	
	Protection against direct touch		None	
	CE marking		Yes	
	UL, cULUS		Yes	

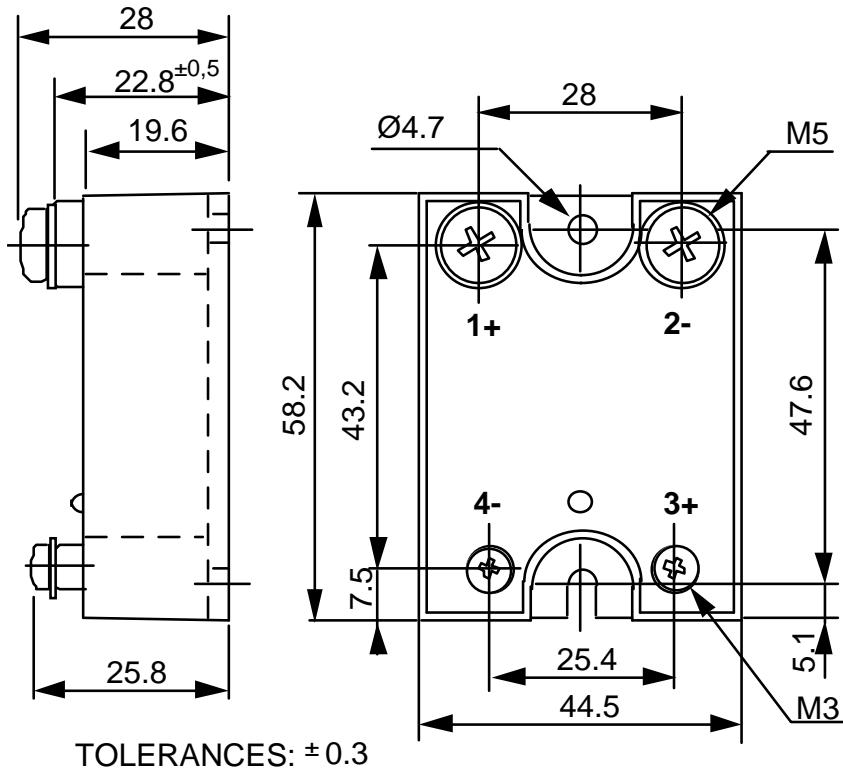
E.M.C. IMMUNITY	TYPE OF TEST	STANDARD	LEVEL	EFFECT
	E.S.D. (Electrostatic discharges)	EN61000-4-2	Pending	?
	Radiated electromagnetic fields	EN61000-4-3	Pending	?
	Fast transients bursts	EN61000-4-4	Pending	No effect
	Electric chocks	EN61000-4-5	Pending	?
	Voltage drop	EN61000-4-11	-	

E.M.C. EMISSION	Radiated and conducted disturbances	NFEN55011	Pending	

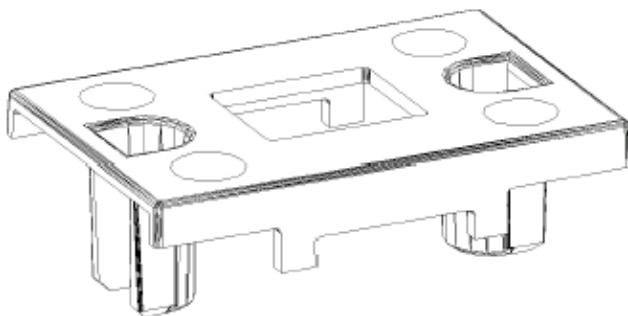
DIMENSIONS AND ACCESSORIES

Fig.
10

DIMENSIONS (mm)



ACCESSORIES

PROTECTIVE COVER
1K470000

Please consult our website for other accessory references
(Heatsinks, mounting adaptors, thermal grease...)

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[TPCC8103,L1Q\(CM](#) [MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [SSM6J414TU,LF\(T](#) [751625C](#) [IPP110N20N3GXK](#)
[IPS70R2K0CEAKMA1](#) [DMN3404LQ-7](#) [NTE6400](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [ECH8691-TL-W](#)
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[DMN1006UCA6-7](#) [DMN16M9UCA6-7](#)